

Harvatek 5.0mm Round LED LAMP HV-57G5023D-TR1-U1856

Official Product	HV-57G5023D-TR1-U1856	Customer Part No.		Data Sheet No.
	*******	********		HV-57G5023D-TR1-U1856
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- 2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

Official Product	HV-57G5023D-TR1-U1856	Customer Part No.		Data Sheet No.
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Specifications are subject to change without notice. Data and drawings herein are copyrighted.		Sep.03 2024	Version of 1.0	Page 2/14

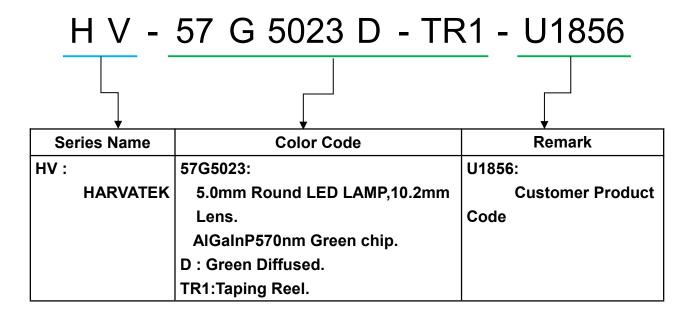


Compliance and Certification

ISO9002, QS9000 and ISO14001 Certified RoHS Compliant



Orderable Information



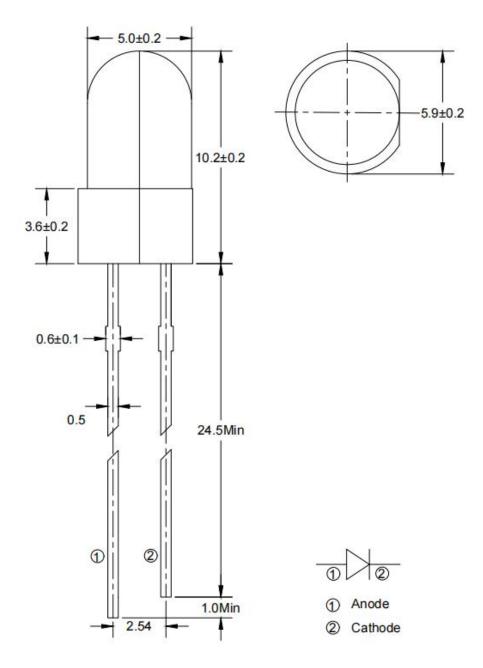
Features:

- Stable Color.
- Popular 5.0mm through hole package, 10.2mm lens height.
- Green Diffused lens.

Official Product	HV-57G5023D-TR1-U1856	Customer Part No.		Data Sheet No.
	*******	********		HV-57G5023D-TR1-U1856
Specifications are subject to change without notice. Data and drawings herein are copyrighted.		Sep.03 2024	Version of 1.0	Page 3/14



Package Dimensions:



Notes:

- 1.All dimensions are millimeters.
- 2. Tolerance is +/-0.25mm unless otherwise noted.
- 3. Specifications are subject to change without notice.

Official Product	HV-57G5023D-TR1-U1856	Customer Part No.		Data Sheet No.
	*******	********		HV-57G5023D-TR1-U1856
Specifications are subject to change without notice. Data and drawings herein are copyrighted.		Sep.03 2024	Version of 1.0	Page 4/14



Absolute Maximum Ratings at Ta=25℃

Parameter	Symbol	Rating	Unit
Forward Current	l _F	30	mA
Operating Temperature	T_{opr}	-40to+85	$^{\circ}$
Storage Temperature	T_{stg}	-40to+85	$^{\circ}$
Soldering Temperature*1	T _{sol}	260	$^{\circ}$
Power Dissipation	P _d	75	mW
Reverse Voltage	V _R	5	V
Peak Forward Current*2	I _{FP}	75	mA

^{*1:}Soldering time ≤ 5 seconds. *2:Pulse Width≤ 100µs and Duty≤ 1%.

Official Product	HV-57G5023D-TR1-U1856	Customer Part No.		Data Sheet No.
	*******	********		HV-57G5023D-TR1-U1856
Specifications are subject to change without notice. Data and drawings herein are copyrighted.		Sep.03 2024	Version of 1.0	Page 5/14



Electrical and Optical Characteristic

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Forward Voltage	V _F	I₅=20 mA	/	2.0	2.4	V
Reverse Current	I _R	V _R = 5 V	/	/	10	μΑ
Luminous Intensity	l _V	I⊧=20 mA	10	40	/	mcd
Viewing Angle	20 1/2	I⊧=20 mA	/	60	/	deg
Dominant Wavelength	λd	I _F =20 mA	/	570	/	nm
Peak Wavelength	λρ	I₅=20 mA	/	575	/	nm
Spectrum Radiation Bandwidth	Δλ	I _F =20 mA	/	20	/	nm

Notes:

 θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.

Official Product	HV-57G5023D-TR1-U1856	Customer Part No.		Data Sheet No.
	*******	********		HV-57G5023D-TR1-U1856
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Specifications for Bin Grading:

lv (mcd)				
Grade	Min.	Max.		
L	10	20		
М	16	32		
N	25	50		
Р	40	80		

λd (nm)				
Grade	Min.	Max.		
5	566	569		
6	568	571		
7	570	573		
8	572	575		
9	574	577		

Notes:

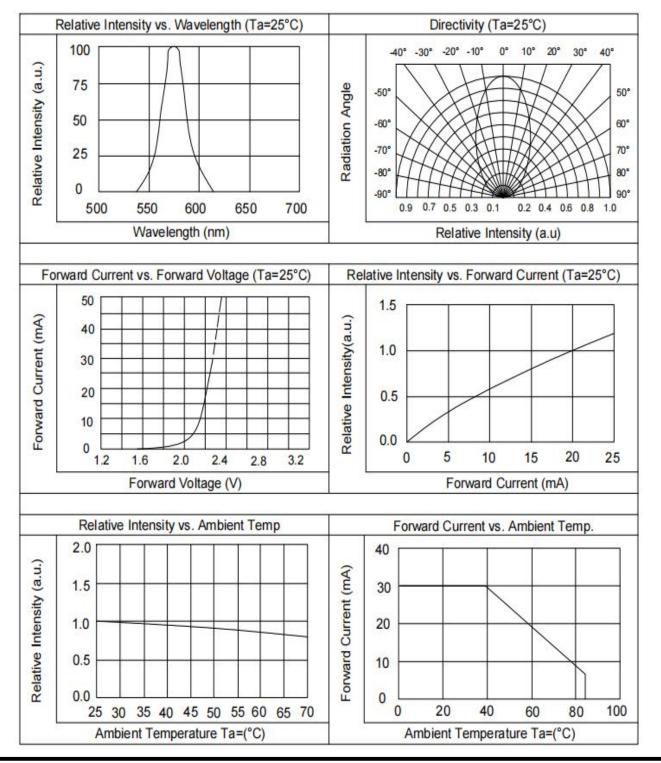
1.Luminous intensity:+/-15%.

2.Wavelength: +/-1nm.

Official Product	HV-57G5023D-TR1-U1856	Customer Part No.		Data Sheet No.
	*******	********		HV-57G5023D-TR1-U1856
Specifications are subject to change without notice. Data and drawings herein are copyrighted.		Sep.03 2024	Version of 1.0	Page 7/14



Typical Electro-Optical Characteristics Curve



Official Product	HV-57G5023D-TR1-U1856	Customer Part No.		Data Sheet No.
	*******	********		HV-57G5023D-TR1-U1856
Specifications are subject to change without notice. Data and drawings herein are copyrighted.		Sep.03 2024	Version of 1.0	Page 8/14

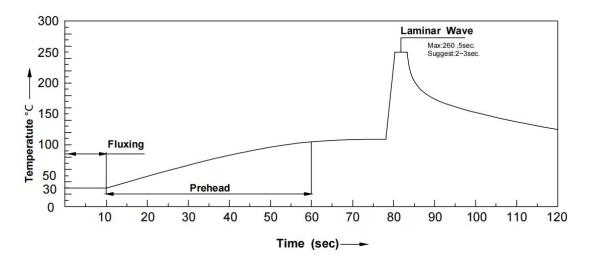


Soldering condition

- 1. Careful attention should be paid during soldering. When soldering, leave more then 2mm from solder joint to Led, and soldering beyond the base of the tie bar is recommended.
- 2. Avoiding applying any stress to the lead frame while the LED are at high temperature particularly when soldering.
- 3. Dip and hand soldering should not be done more than one time.
- 4. After soldering the LED, the epoxy bulb should be protected from mechanical shock or vibration until the LED return to room temperature.
- 5. A rapid-rate process is not recommended for cooling the LED down from the peak temperature.
- 6. Although the recommended soldering conditions are specified in the above table, dip or hand soldering at the lowest possible temperature is desirable for the LED.
- 7. Wave soldering parameter must be set and maintain according to recommended temperature and dwell time in the solder wave.

Recommended soldering conditions

Har	nd Soldering	Wave Soldering		
Temp. at tip of iron	300℃ Max. (30W Max.)	Preheat temp.	100℃ Max. (60 sec Max.)	
Soldering time	3 sec Max.	Bath temp. & time	260℃ Max., 5 sec Max	
	2mm Min.(From solder joint to			
Distance	Led)	Distance	to Led)	



Official Product	HV-57G5023D-TR1-U1856	Customer Part No.		Data Sheet No.
	*******	*******		HV-57G5023D-TR1-U1856
1 -	Specifications are subject to change without notice. Data and drawings herein are copyrighted.		Version of 1.0	Page 9/14



Reliability test items and conditions:

The reliability of products shall be satisfied with items listed below.

Confidence level: 97%.

LTPD:3%.

No	Item	Test Conditions	Test Hours/Cycle	Sample Size	Failure Judgment Criteria	Ac/Er
1	Solder Heat	TEMP:260℃±5℃	10 SEC	76 PCS		0/1
2	Temperature Cycle	H:+100°C 15min ∫ 5min L:-40°C 15min	300 CYCLES	76 PCS		0/1
3	Thermal Shock	H:+100°C 5min ∫ 10sec L:-10°C 5min	300 CYCLES	76 PCS	lv≦lvt*0.5 or	0/1
4	High Temperature Storage	TEMP:100℃	1000 HRS	76 PCS	Vf≧U or	0/1
5	Low Temperature Storage	TEMP:-40 ℃	1000 HRS	76 PCS	Vf≦L	0/1
6	DC Operating Life	TEMP:25°C IF=20mA	1000 HRS	76 PCS		0/1
7	High Temperature / High Humidity	85℃/85%RH	1000 HRS	76 PCS		0/1

Note: Ivt: To test Iv value of the chip before the reliability test.

Iv: The test value of the chip that has completed the reliability test.

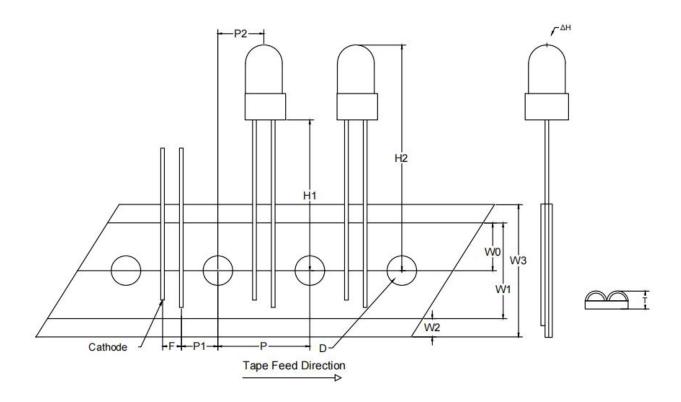
U: Upper Specification Limit.

L: Lower Specification Limit.

Official Product	HV-57G5023D-TR1-U1856	Customer Part No.		Data Sheet No.
	*******	*******		HV-57G5023D-TR1-U1856
Specifications are drawings herein ar	subject to change without notice. Data and re copyrighted.	Sep.03 2024	Version of 1.0	Page 10/14



Carrier Tape Dimensions:



Notes:

Lead spacing is measured where the lead emerge from the package.

Official Product	HV-57G5023D-TR1-U1856	Customer Part No.		Data Sheet No.
	*******	********		HV-57G5023D-TR1-U1856
Specifications are drawings herein ar	subject to change without notice. Data and re copyrighted.	Sep.03 2024	Version of 1.0	Page 11/14



Taping Sizes

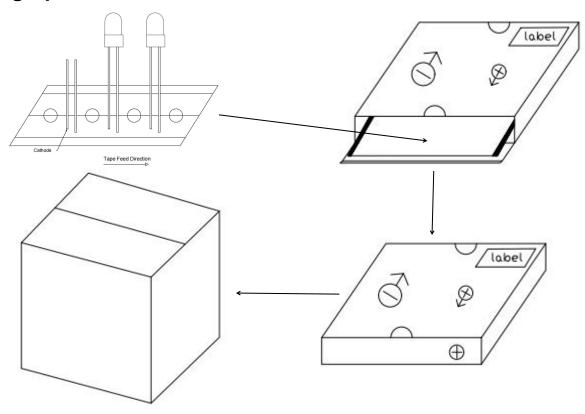
		Specifications			
Symbol Items	Symbol	Avg.		Tolerance	
		mm	Inch	(mm)	
Tape Feed Hole Diameter	D	4	0.157	±0.2	
Component Lead Pitch	F	2.54	0.100	±1.0	
Front-to-Read Deflectio	ΔΗ	2	0.079	±5°	
Feed Hole to Button of Component	H1	23.8	0.937	±1.0	
Feed Hole to Overall Component Height	H2	34	1.339	±1.0	
Feed Hole Pitch	Р	12.5	0.492	±0.3	
Lead Location	P1	5	0.197	±1.0	
Center of Component Location	P2	6.25	0.246	±1.2	
Overall Taped Package Thickness	Т	1.42	0.056	MAX	
Feed Hole Location	W0	6.5	0.256	±0.5	
Adhesive Tape Width	W1	13	0.512	±0.5	
Adhesive Tape Position	W2	2.5	0.098	±1.0	
Tape Width	W3	18	0.709	±1.0	

Note: Tolerances unless mentioned ±1mm. Unit = mm.

Official Product	HV-57G5023D-TR1-U1856	Customer Part No.		Data Sheet No.
	*******	******		HV-57G5023D-TR1-U1856
Specifications are drawings herein ar	subject to change without notice. Data and e copyrighted.	Sep.03 2024	Version of 1.0	Page 12/14



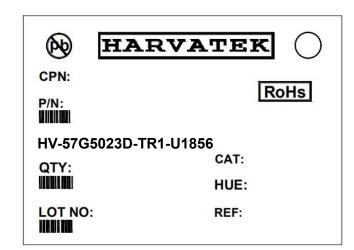
Packing Specification:



Packing Quantity: 2000PCS/In-Carton, 20000PCS/Out-Carton.

Note:

After packing into the box, the head is located in the box large negative symbol upward, positive symbol facing themselves



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Specifications are drawings herein a	subject to change without notice. Data and re copyrighted.	Sep.03 2024	Version of 1.0	Page 13/14



Revision History

Revision	Page	Version No.	Revision Date
Initial Release		1.0	09-03-2024

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	*******	*******		HV-57G5023D-TR1-U1856
Specifications are drawings herein ar	subject to change without notice. Data and e copyrighted.	Sep.03 2024	Version of 1.0	Page 14/14